



# Upgrade of ATLAS Hadronic Tile Calorimeter for the High Luminosity LHC

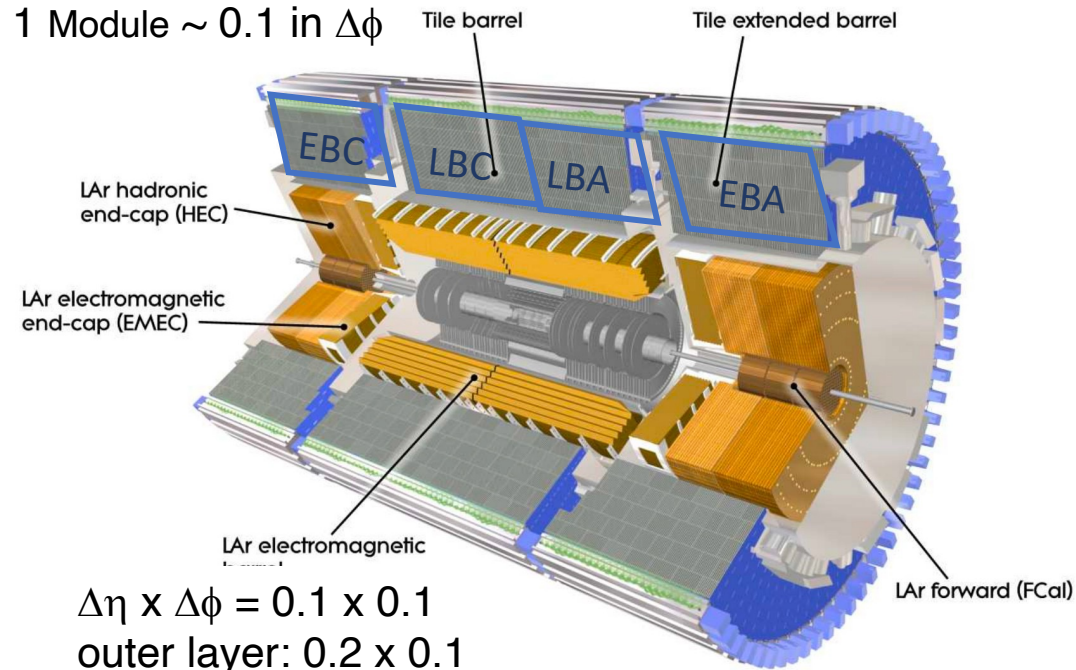


**Sandra Leone (INFN Pisa)**  
on behalf of the ATLAS Tile Calorimeter system

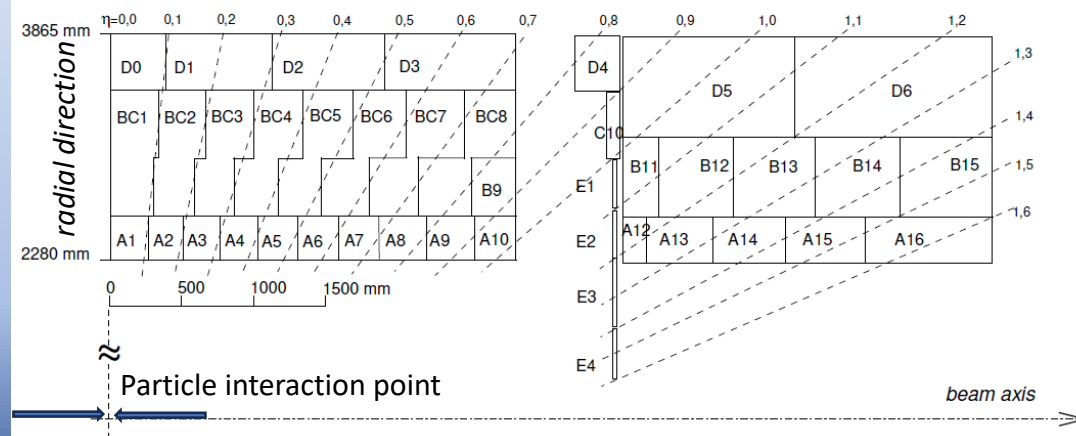
16<sup>th</sup> Topical Seminar on Innovative Particle and Radiation Detectors  
(IPRD23) 25-29 September 2023 Siena, Italy

Tile Calorimeter (TileCal) is the central section ( $|\eta| < 1.7$ ) of ATLAS hadron calorimeter

1 Module  $\sim 0.1$  in  $\Delta\phi$



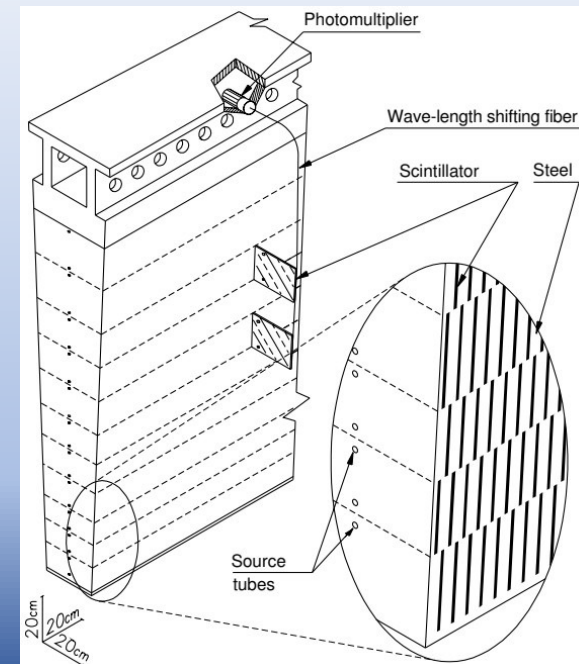
$\Delta\eta \times \Delta\phi = 0.1 \times 0.1$   
outer layer:  $0.2 \times 0.1$



- Four partitions: one Long Barrel (LBA+LBC) and two Extended Barrels (EBA, EBC) each composed of 64 modules in  $\phi$
- Coverage  $|\eta| < 1.0$  (LB),  $0.8 < |\eta| < 1.7$  (EB).
- Sampling calorimeter: steel absorbers and plastic scintillators (the “tiles”) coupled to wavelength shifting (WLS) fibers.
- About 5000 pseudo-projective cells.
- Each cell readout by 2 PMTs ( $\sim 10k$  readout channels in total).
- Energy resolution for hadrons:

$$\frac{\sigma}{E} = \frac{50\%}{\sqrt{E}} \oplus 3\%$$

- Dynamic range from  $\sim 10$  MeV to  $\sim 2$  TeV per calorimeter cell





- High Luminosity (HL) LHC, starting around 2029, will achieve an instantaneous luminosity 5-7 higher than the LHC nominal value and total integrated luminosity of  $\sim 4000 \text{ fb}^{-1}$  at the end (2029-2040)
  - high radiation environment
  - high pile-up contribution, from 60 in Run3 → up to 200 collisions per bunch crossing
- Lifetime of TileCal extended → Readout electronics is ageing due to operation time and to radiation
- Current readout architecture is not compatible with the new fully digital TDAQ system of ATLAS and with the timing requirements for trigger and data flow.
  - Technical challenges coming from the HL-LHC are huge and complicated

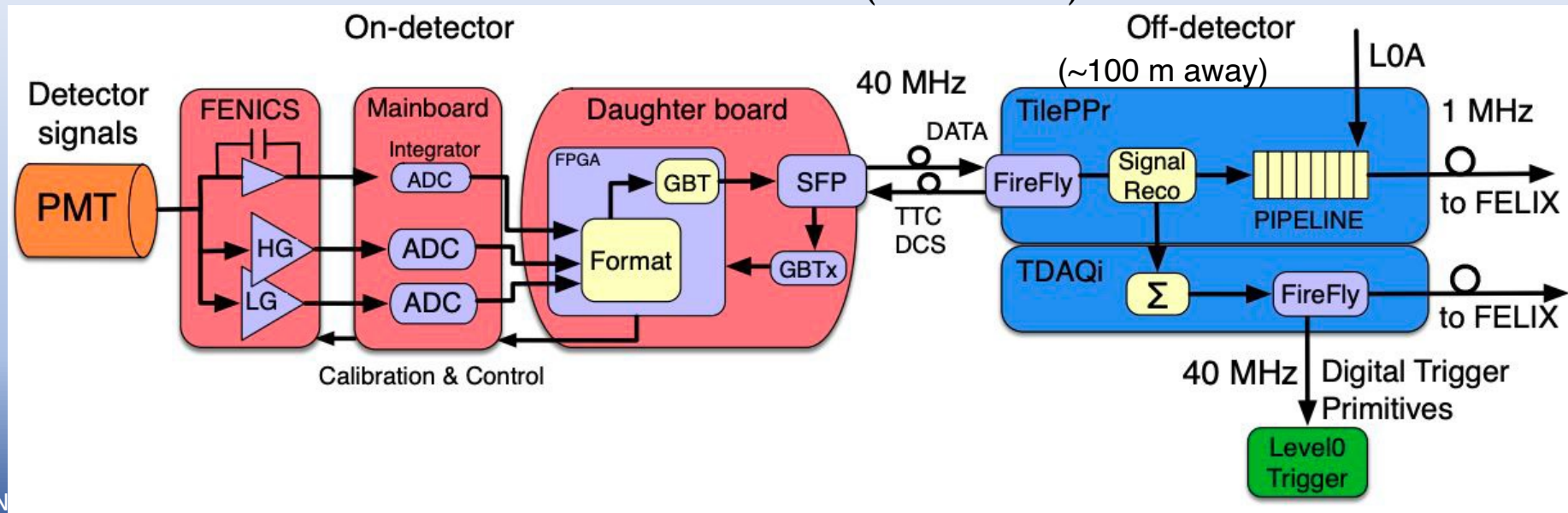
## TileCal upgrade strategy:

- Replace the full readout system to:
  - handle the increase in the data rate
  - enhance radiation tolerance of the on-detector electronics
  - be compatible with the fully digital ATLAS Trigger/DAQ system
- Improve reliability through redundancy → reduces impact of component failures
- The scintillating tiles and WLS fibers are built into the detector → will not be modified.

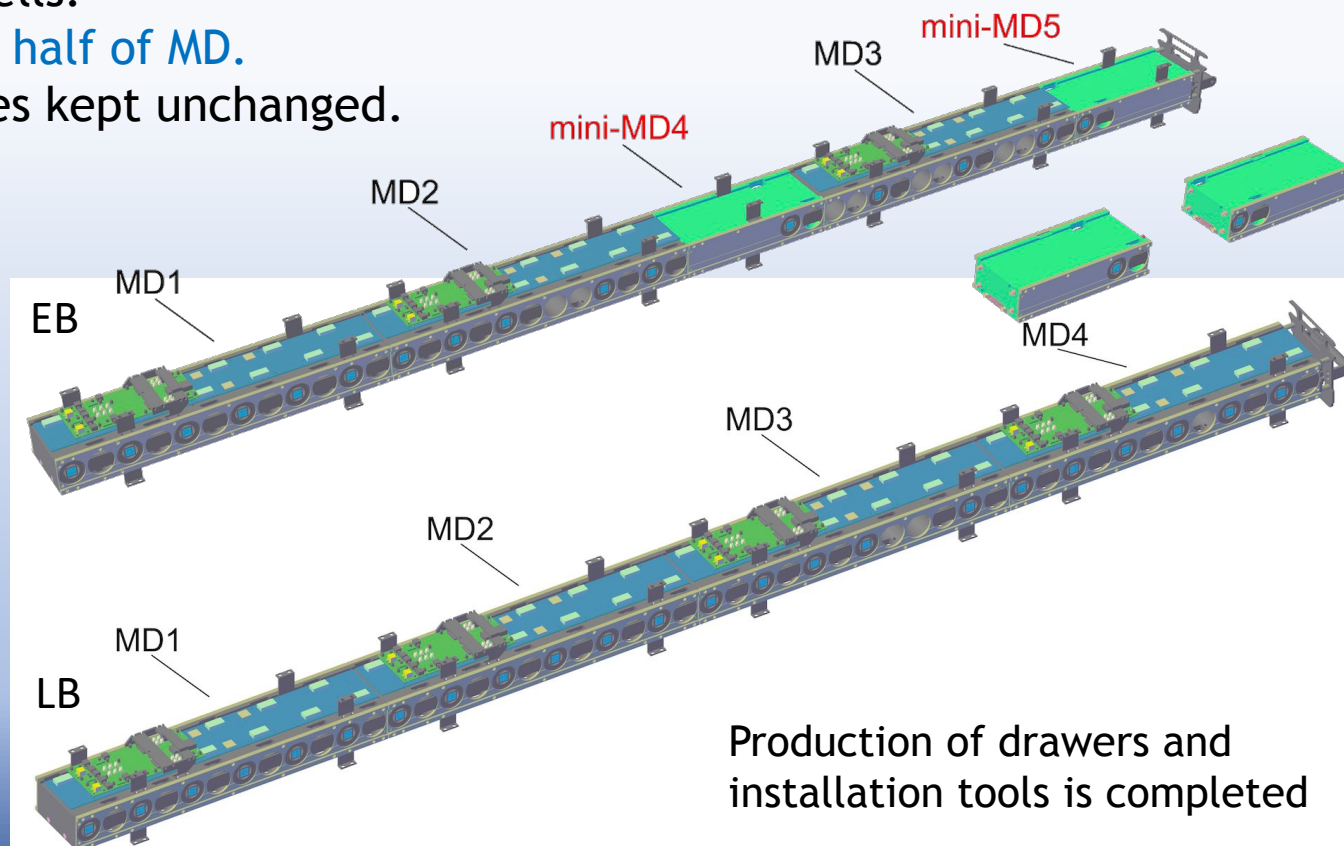
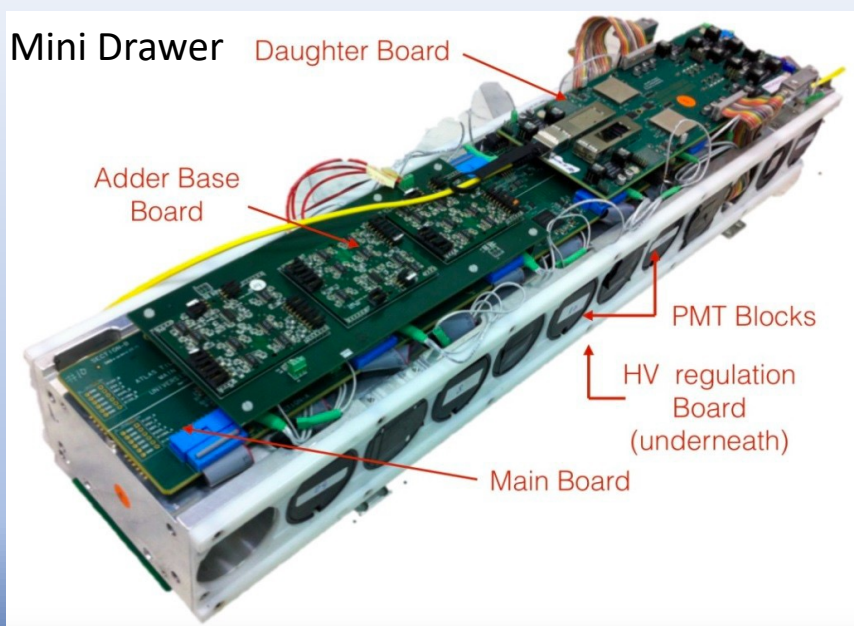


- Complete replacement of on-detector and off-detector electronics.
- Increased detector read-out bandwidth: 40 Tbps for the entire TileCal.
- Compatibility with new digital ATLAS trigger system up to 40 (1) MHz read-out (accept) rate.
- New mechanical structure for the on-detector electronics → easier access for maintenance.
- New high voltage active dividers for all PMTs and replacement of 10% of most exposed PMTs.
- Improved High Voltage (HV) and Low Voltage (LV) distribution systems
- New control electronics for the Cs source system.
- New control/readout electronics for the laser system and upgraded optical line.

HL-LHC architecture (2029-2040)



- Currently Tile on-detector electronics is housed in long Super-Drawers: difficult to extract to access electronics.
- The upgrade mechanics has substructures (Mini-Drawers) to facilitate access during maintenance.
- Different configuration for Long and Extended Barrel modules:
  - 4 Mini-Drawers (MD) for Long Barrel modules → 45 PMTs
  - 3 MD + 2 micro-drawers for Extended Barrel modules → 32 PMTs
- Each mini-drawer is divided into two independent sections for redundant cell readout, accommodating 12 PMT blocks for 6 TileCal cells.
- Independent electronics and readout for each half of MD.
- Remaining mechanics of the individual modules kept unchanged.

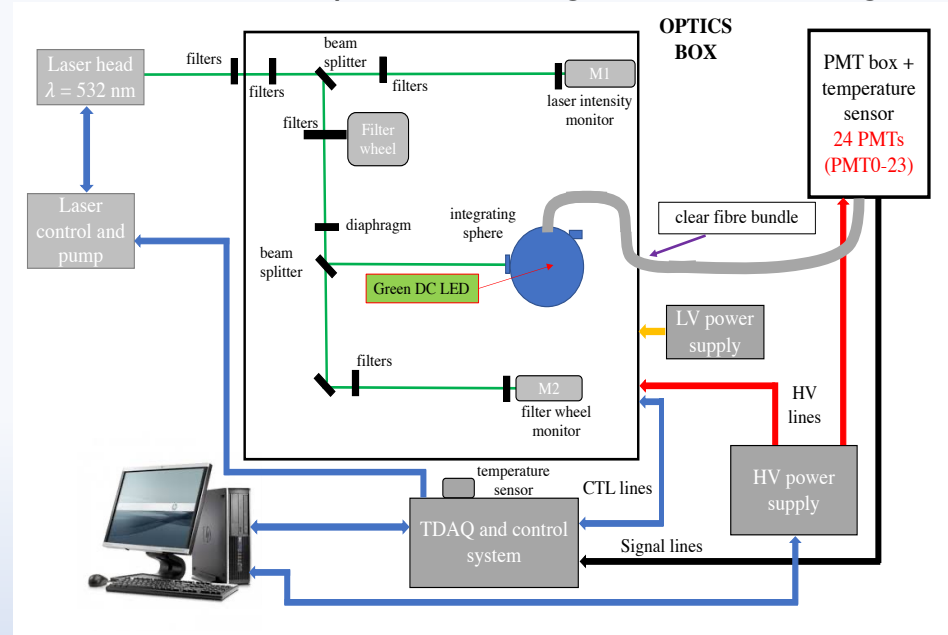


Production of drawers and installation tools is completed

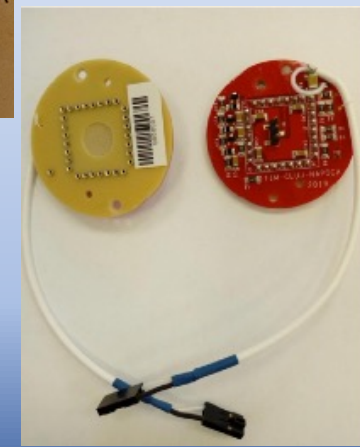
# The PMT Block (I)

- 1024 PMTs out of 9852 will be replaced due to ageing effects (those reading the most exposed cells: expected response loss > 25%)
- Characterization of new Hamamatsu PMT model R11187 used for replacement (same geometry as legacy model, better response stability) was done in Pisa (for more details see also the POSTER: *“Long term aging studies of the new PMTs for the HL-LHC ATLAS hadron calorimeter upgrade”*)
- Dedicated test-benches are operational at Bratislava, Pisa and CERN to test and qualify new PMTs.
- Tests of first production batch (20 PMTs) performed in the 3 sites in Summer 2023
- Passive HV dividers will be replaced with active dividers to provide response linearity at high anode currents (up to 100  $\mu\text{A}$ ) (production and testing completed).

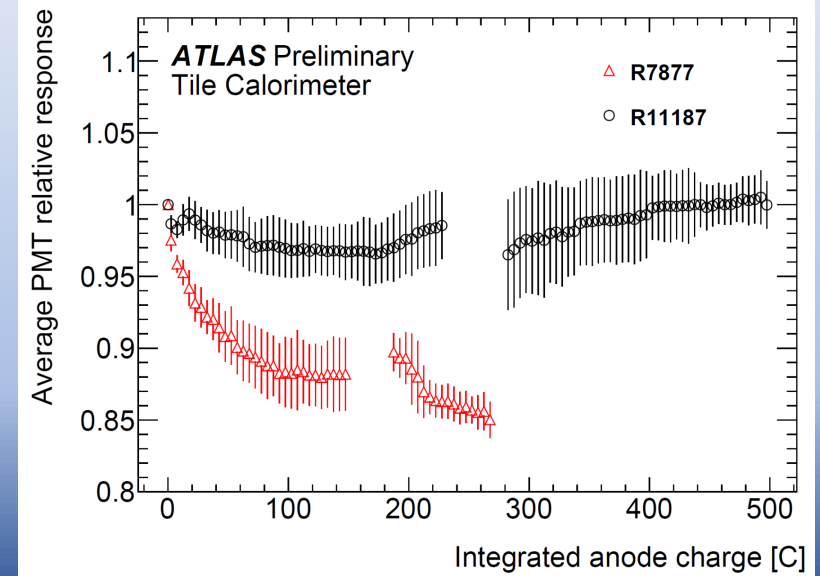
Pisa setup used for long term PMT testing



Hamamatsu PMT



New active HV dividers





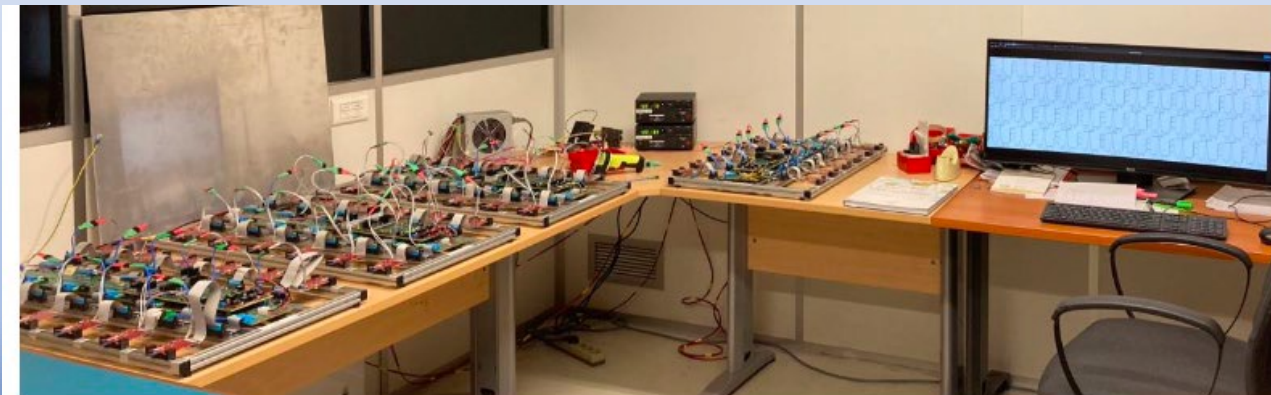
## On detector electronics → new Front End board: the FENICS

(Front End board for the New Infrastructure with Calibration and signal Shaping)

- Provides PMT pulse shaping with 2 gain amplifications (LG:x0.4, HG:x16), 0.2 pC to 1000 pC dynamic range.
- High precision integration of slow signals for  $^{137}\text{Cs}$  calibration and for luminosity measurements.
- Built-in Charge Injection system for ADC calibration.
- Analog signals are sent to the next step of the readout chain: the Main Board.
- Production and burn-in tests are in progress.



FENICS card



Production FENICS test-bench @ Clermont Ferrand

69 cm long board, FPGAs used only for configuration

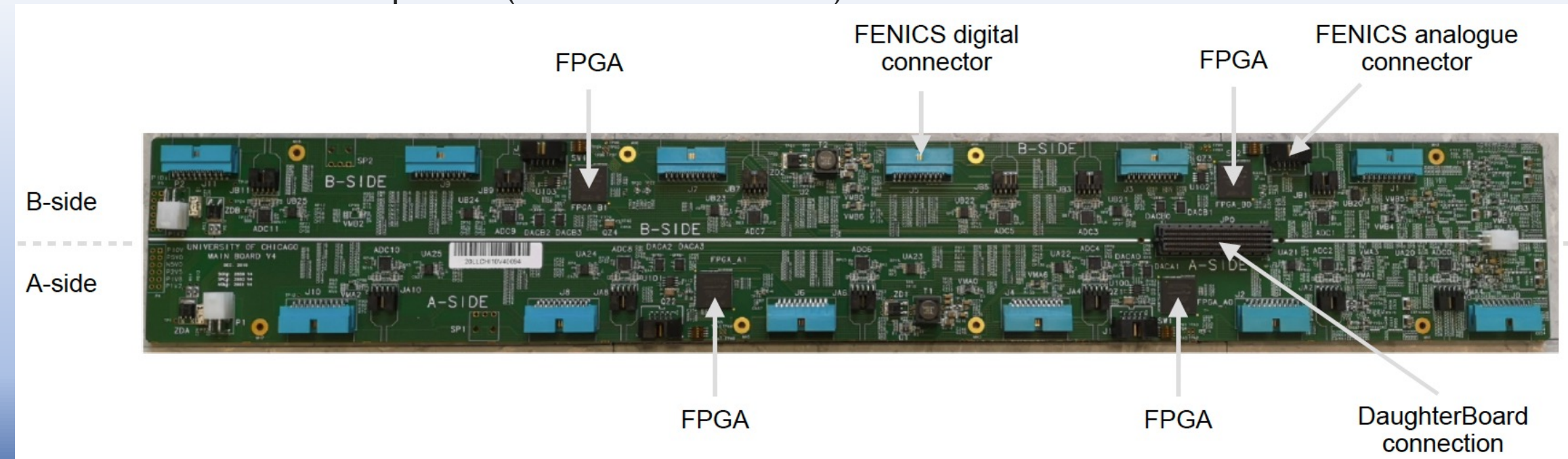
One Main Board installed in each MD receives and digitises the analog signals from 12 FENICS

- 12 bit dual ADCs at 40 Msample/s for 2 gain signals.
- 16 bit ADC at 50 ksamples/s for integrated signal readout.

Provides digital control and configuration of FENICS + high-speed transmission to the DaughterBoard

- Divided in two halves for redundancy → independent read-out and LV power distribution to all on-detector electronics.

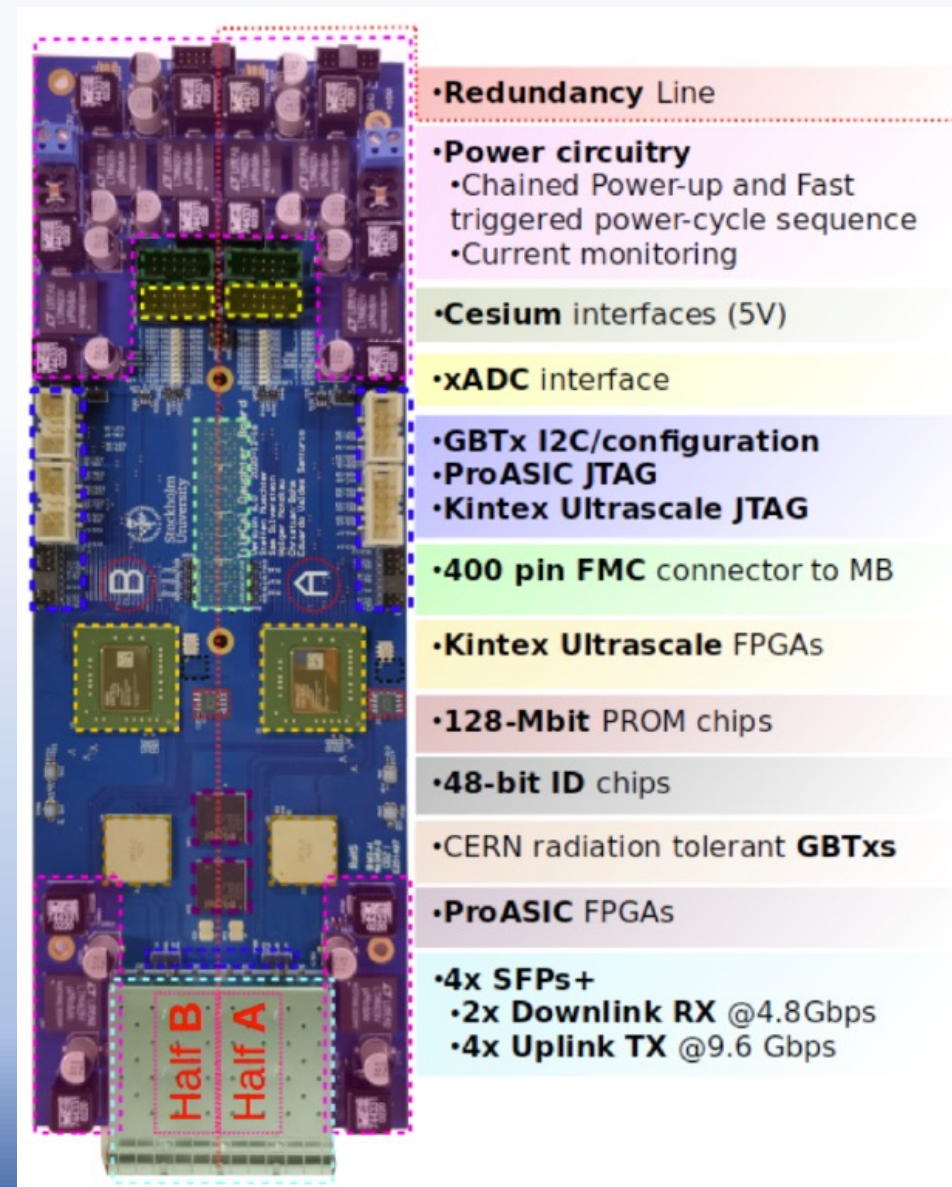
Production is close to completion (845 boards out of 896).





High-speed interface with the off-detector electronics:

- Collects PMT digitized data from the MainBoard.
- Interfaces to off-detector electronics through optical links  
→ 4 uplinks @ 9.6 Gbps
- Clock and commands recovery and distribution.
  - Uses 2 GBTx chips for LHC clock recovery and distribution
  - 2 Kintex Ultrascale(+) FPGAs for communication and data processing
  - 2 QSFP high-speed optical modules
- Each side provides control and readout services for 6 PMTs (12 in total)
- A massive campaign of SEE, TID and NIEL radiation tests was performed for most of the active components and KU FPGAs
- Design to be finalized in 2023.



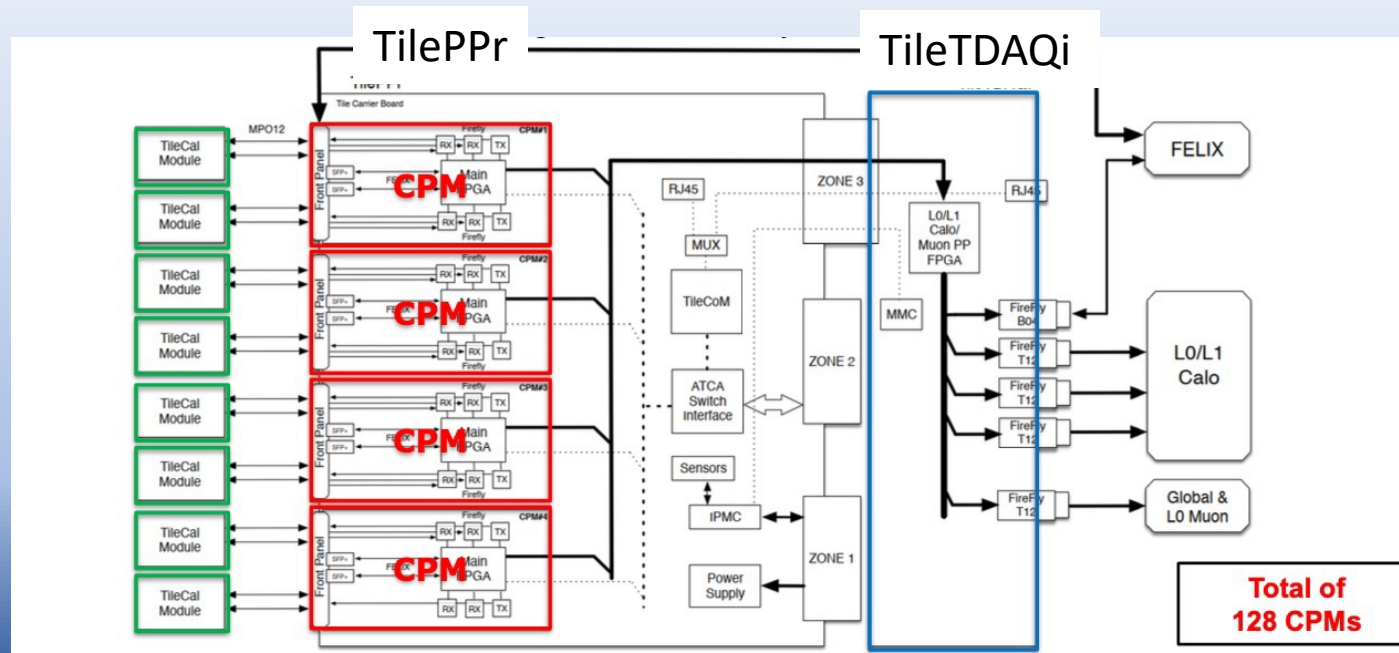
The back-end electronics is formed by Tile PreProcessor (PPr) and TDAQi systems.

- Real time data processing, handling and reconstruction from on-detector electronics
- Storage of up to 10  $\mu$ s of consecutive data samples in pipeline memories
- Provides clocks and configuration for the TileCal modules
- Interface with the ATLAS trigger and read-out systems (FELIX)

Each PPr formed by 1 ATCA carrier + 4 Compact Processing Modules (CPM)  $\rightarrow$  32 PPr in total

- Each CPM receives data from 2 modules (8 minidrawer)  $\rightarrow$  128 CPMs in total

32 Tile TDAQi in total: Interfaces with LOCalo, LOMuon, Global, and FELIX system



## Low Voltage:

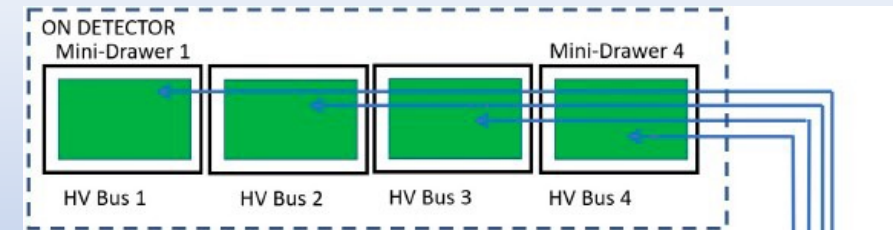
The high radiation environment on-detector requires Rad-Hard DC-DC converters.

- There are strong constraints in terms of radiation tolerance, noise, power efficiency and reliability.
- 200 V DC is transformed to 10 V DC to power the Point of Load regulators on the on-detector electronics boards.
- Lower number of connections (single DC level (+10V) and regulators for the voltages needed).
- Redundant power distribution → two bricks connected to each MD, one for the up and one for the down half.

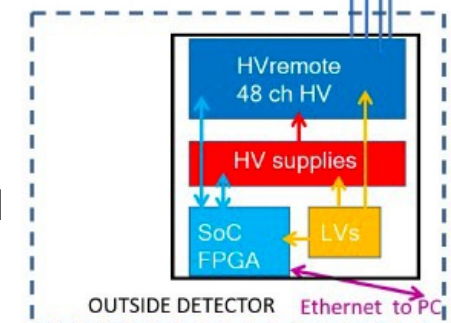
## High Voltage: new concept

HV power supplies (48-channel boards) and regulators are installed in the ATLAS service cavern (USA15)

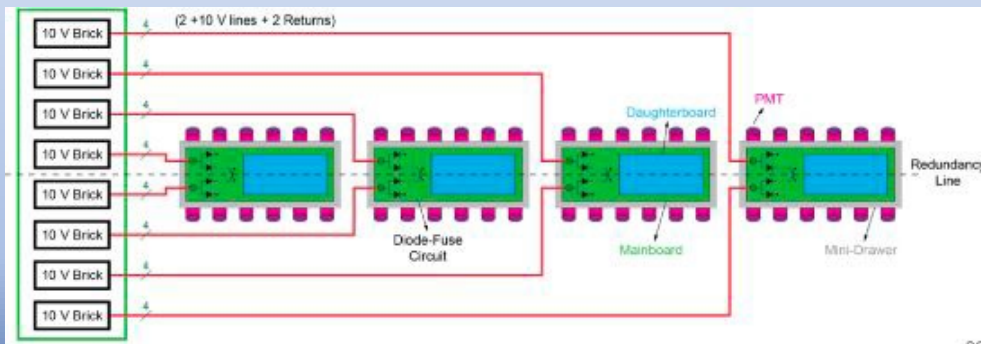
- 100 m long HV cables for each PMT.
- HV bus board set high voltage to individual PMTs
- Easy maintenance, no radiation hardness issues
- Prototypes were produced and validated during the test-beam at CERN SPS since 2018.



Good linearity up to current of 100  $\mu$ A (max 40  $\mu$ A expected for most exposed cells).

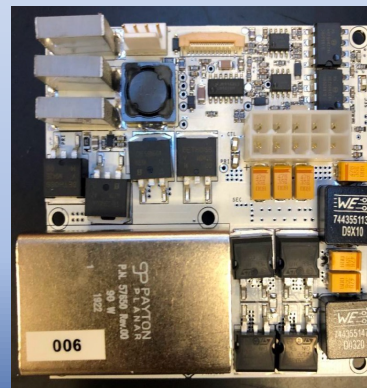


HV distribution scheme



Low voltage power distribution scheme.

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Low voltage brick

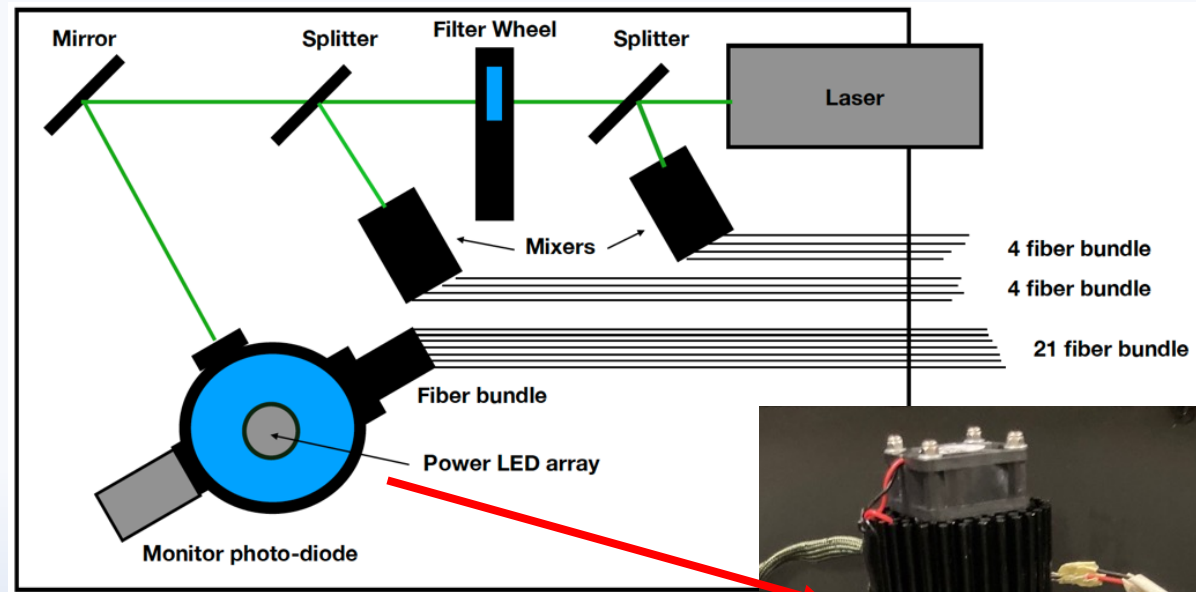


## Laser Calibration system

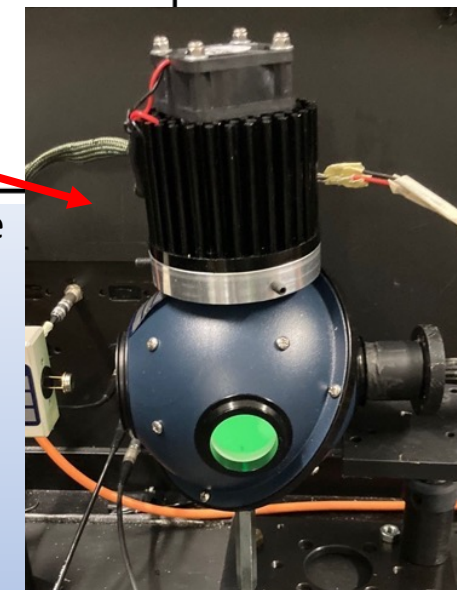
- New TDAQ interface and control electronics board is under test at CERN.
- We will also replace the pulsed laser and add a continuous light source (LED array) to mimic the actual regime during collisions.
- The optical line is being redesigned: an integrating sphere used to mix pulsed and DC light.

## Cesium calibration system

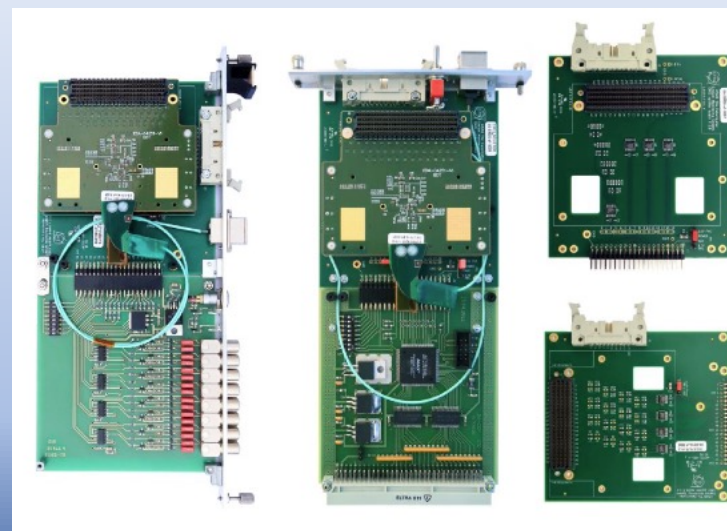
- The on and off-detector electronics will be replaced.
- The new electronics is designed around the CERN EMCI-EMP systems.
- Design of all boards is ready, all prototypes were produced and are under test.
- NIEL and SEU tests were performed, TID tests in progress.



Preliminary scheme of new optical line



Power LED array positioned on top of Integrating sphere



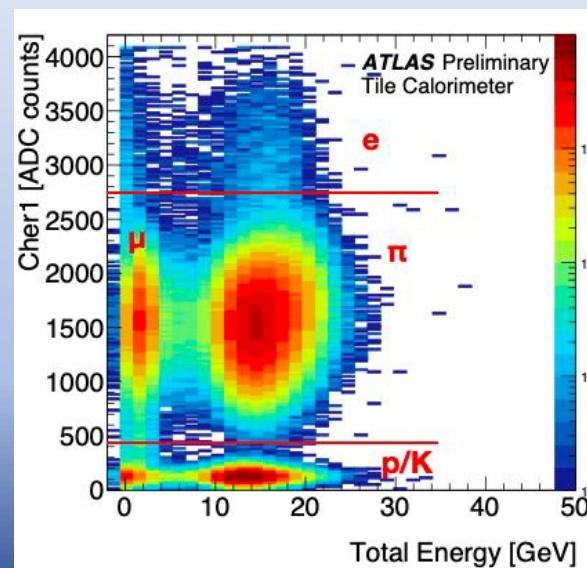
New Cs electronics prototype

# Test-beam at the SPS

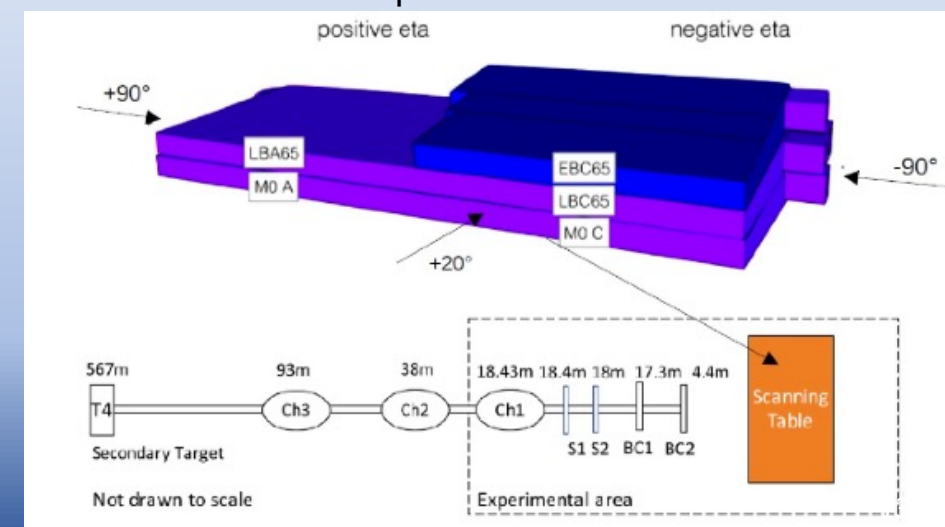
- Many test-beam campaigns were performed in the SPS-H8 beam line between 2015 and 2023 to validate the hardware and carry out physics studies
  - 3 modules from the calorimeter (two Long-Barrel and one Extended-Barrel)
- Different designs of the front-end electronics have been tested over the years
- The setup is partially equipped with new electronics
- We used electron, muon and hadron beams of various energies and the detector positioned in different orientation
- Cherenkov detectors, part of the beam instrumentation, allow for particle ID



TileCal setup in the SPS-H8 beam-line.



Cherenkov 1 signal vs. energy measured in the calorimeter for 18 GeV particle beams

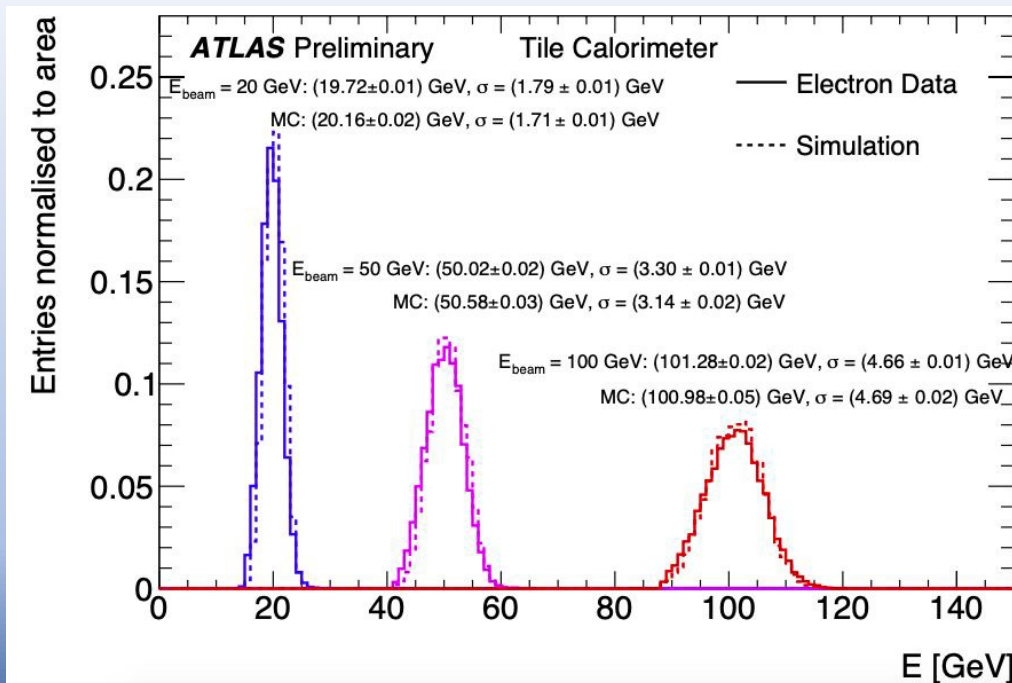
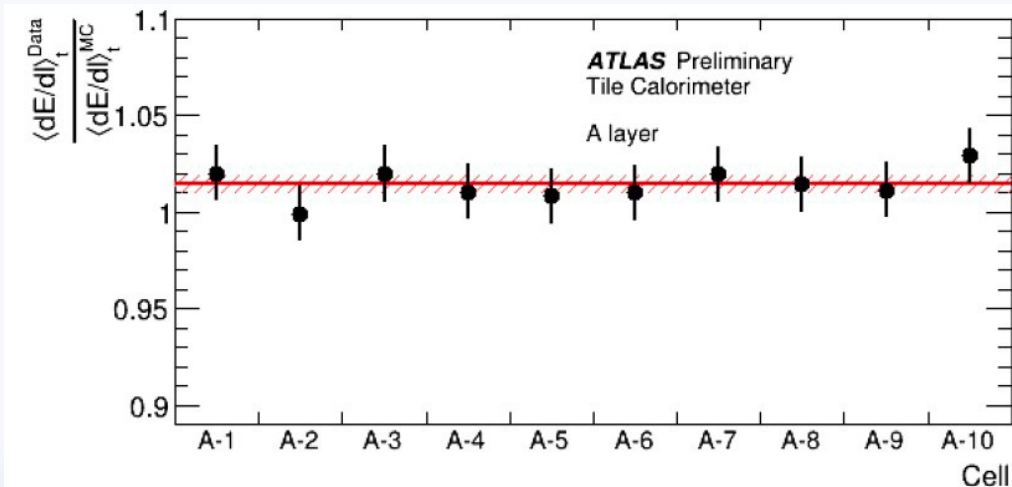


## Muons:

- On top, results from 165 GeV/c Muons that cross the entire TileCal modules with an angle of 90°, with new electronics (May 2018 campaign).
- The deposited energy is a function of the muon path length in each cell → **checking the equalization of the cell response.**
- Layer uniformity within 1%, very good agreement of data and simulations.

## Electrons:

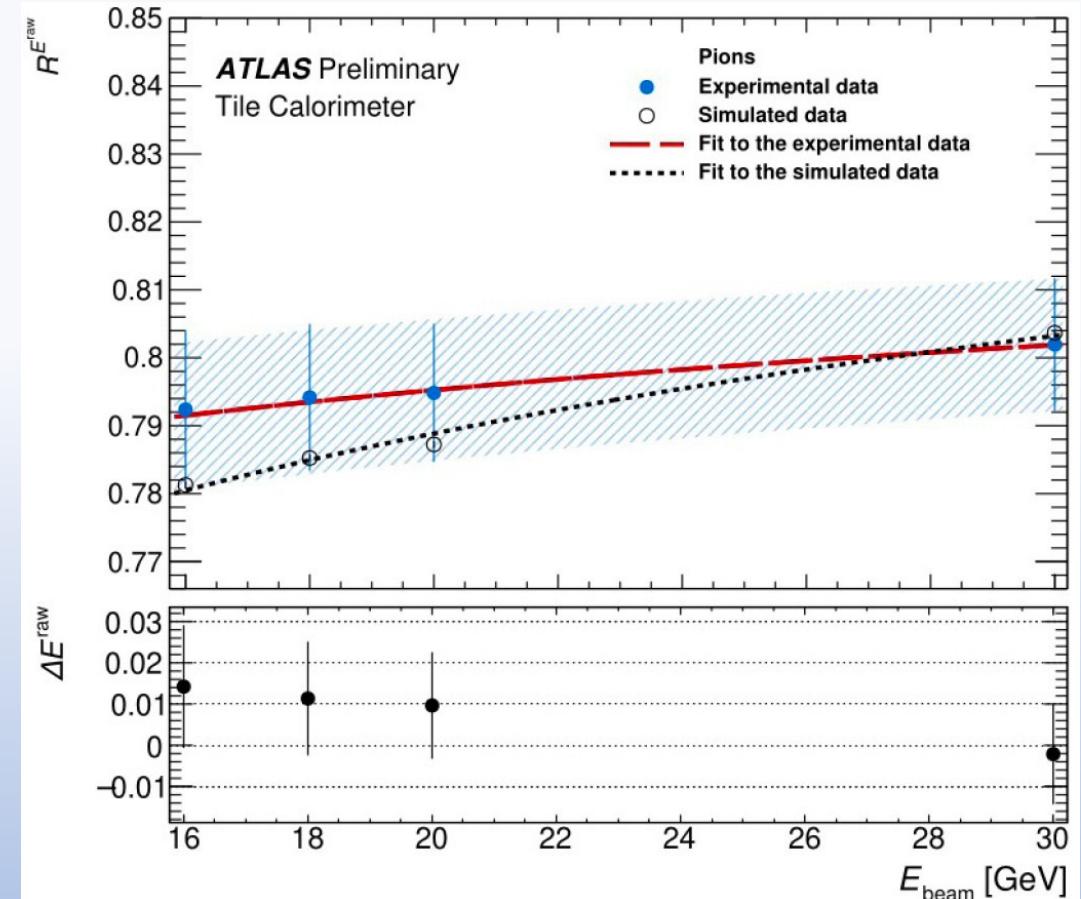
- Below, electrons of different energies are used to determine the EM scale by calculating the **average charge-to-energy conversion factor, (pC/GeV).**
- We could verify the response linearity and the energy resolution as function of the electron energy





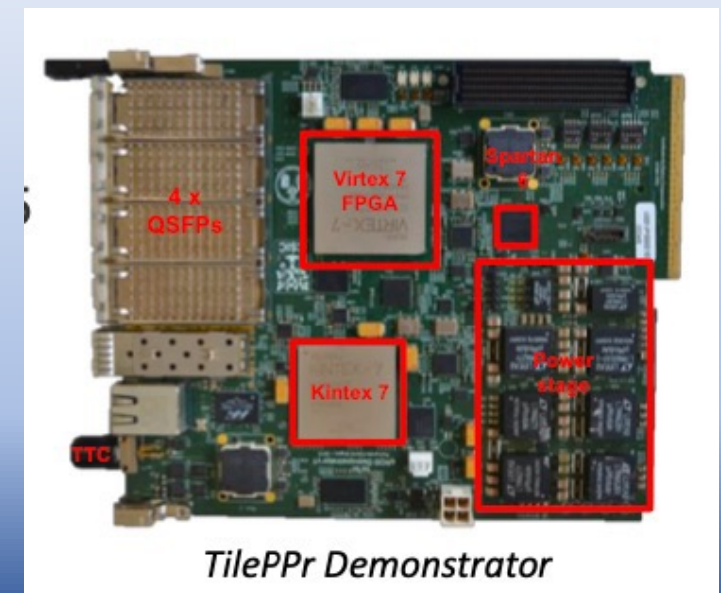
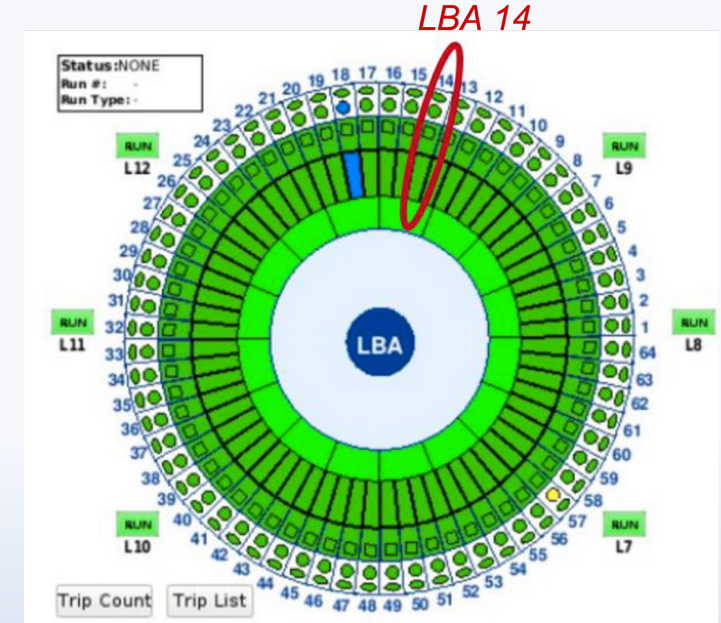
## Hadrons:

- Response to isolated hadrons is important to validate and improve the modeling for jet and tau measurements in ATLAS.
  - The beam composition is a mix with a majority of  $\pi$ , K and protons with fractions not known a priori.
  - Kaon content is small in the beam  $\rightarrow$  dominated by statistical errors
  - Protons have high statistics  $\rightarrow$  low systematic and statistical uncertainties
  - For pions, electron contamination plays an important role.
- 
- More results in: EPJC 81 (2021) 549



$$R^{\langle E^{\text{raw}} \rangle} = \frac{\langle E^{\text{raw}} \rangle}{E_{\text{beam}}} \quad \Delta \langle E^{\text{raw}} \rangle = \frac{\langle E^{\text{raw}} \rangle}{\langle E_{\text{MC}}^{\text{raw}} \rangle} - 1$$

- In Summer 2019, we installed a special module equipped with upgrade mechanics/electronics (“*Demonstrator*”) in one of the TileCal long barrel modules of the ATLAS detector.
- It is backward compatible with the current DAQ system: dual read-out → Legacy and Phase II.
- It has proven a very useful exercise to learn about the new electronics and timely identify problems.
- Embedded into legacy calibration systems (pedestal, laser, charge injection system (CIS)).  
→ Stable, good CIS and laser signals.
- **It was decided to keep it in for Run-3.**
- Good performance with low noise levels wrt the legacy modules.
- Currently, the Demonstrator module provides physics data from proton-proton collisions with the rest of the TileCal modules.
- Aiming to install a second special module in the extended barrel.



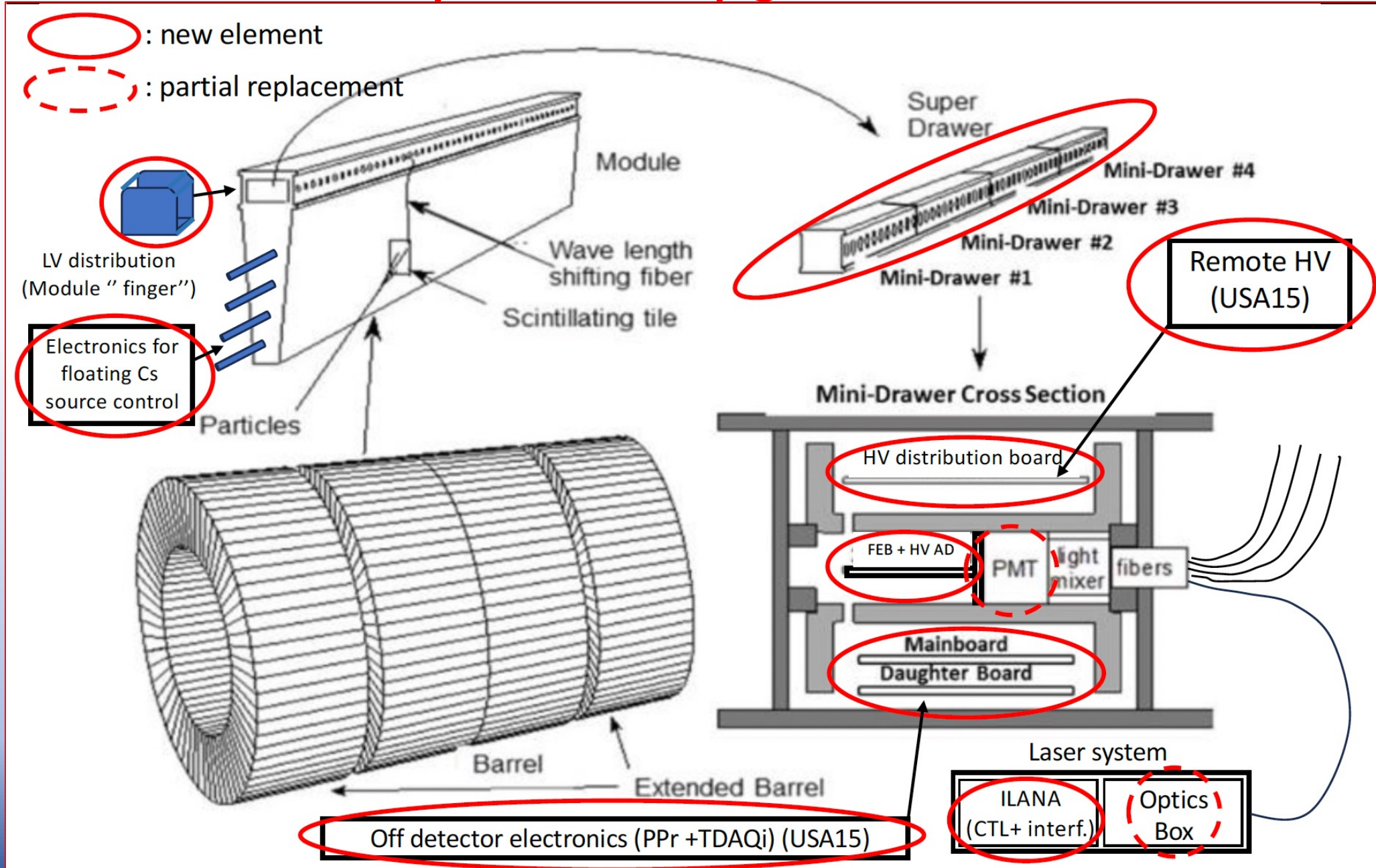
- The High-Luminosity LHC era will bring new challenges:
  - a harsher radiation environment, higher pile-up, higher luminosity and readout rates
- In order for TileCal to continue to play a crucial role for ATLAS physics program an upgrade is required:
  - replace all on- and off-detector electronics and 10% of the PMTs in LS3 (2026-2028)
  - new mechanical structure (more reliable and easier to service) and electronics (more radiation hard)
  - new digital readout and trigger path, ready for 1 MHz first level trigger rate.
- Regular test-beam campaigns are helping to validate designs and integrate different components of the upgraded detector
- The Tile Demonstrator in ATLAS is fully integrated in the current ATLAS DAQ and DCS systems, and it is taking Run 3 data.

**The overall project is on track and advancing well**

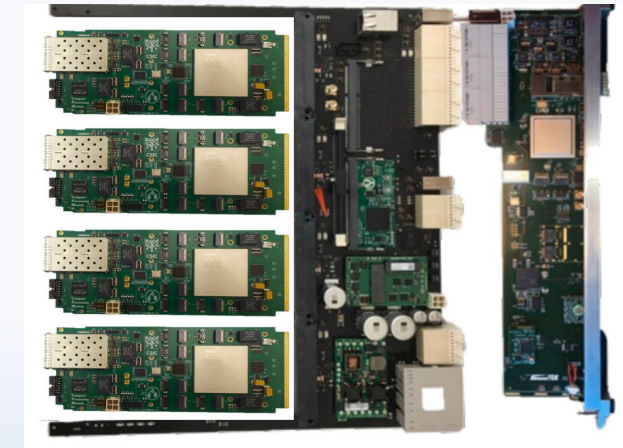


Backup

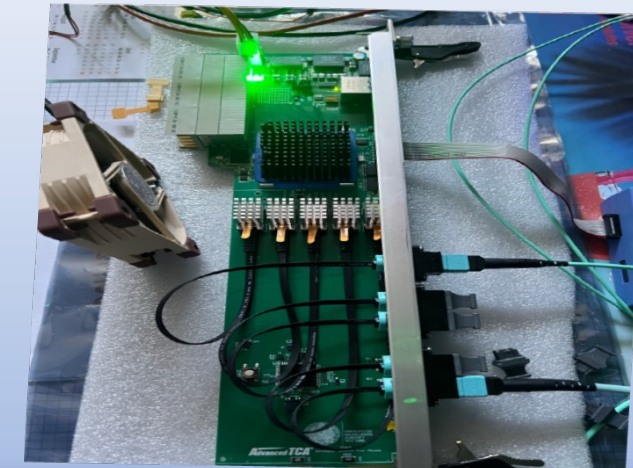
# TileCal components upgraded for HL-LHC



- Each PPr comprises 1 Carrier + 4 CPM and processes data from 8 modules (2 modules per CPM)
  - Processing, data handling from “on detector” electronics and pipeline of data.
  - Distribution of the LHC clock towards the on-detector electronics.
  - Interface with the ATLAS read-out system FELIX.
  - Communication with the Timing, Trigger and Control system for the LHC.
- The TDAQi is connected to the rear side of the Carrier.
- Receives the cell energies from 4 CPMs synchronously
  - Calculation of the trigger objects (trigger towers or cluster in  $(\eta, \Phi)$ ).
  - Building and synchronous transmission of trigger objects to the different electron/photon, jet, muon trigger sub-systems and Global trigger.
  - It sends monitoring data to the FELIX system.



PPr carrier boards



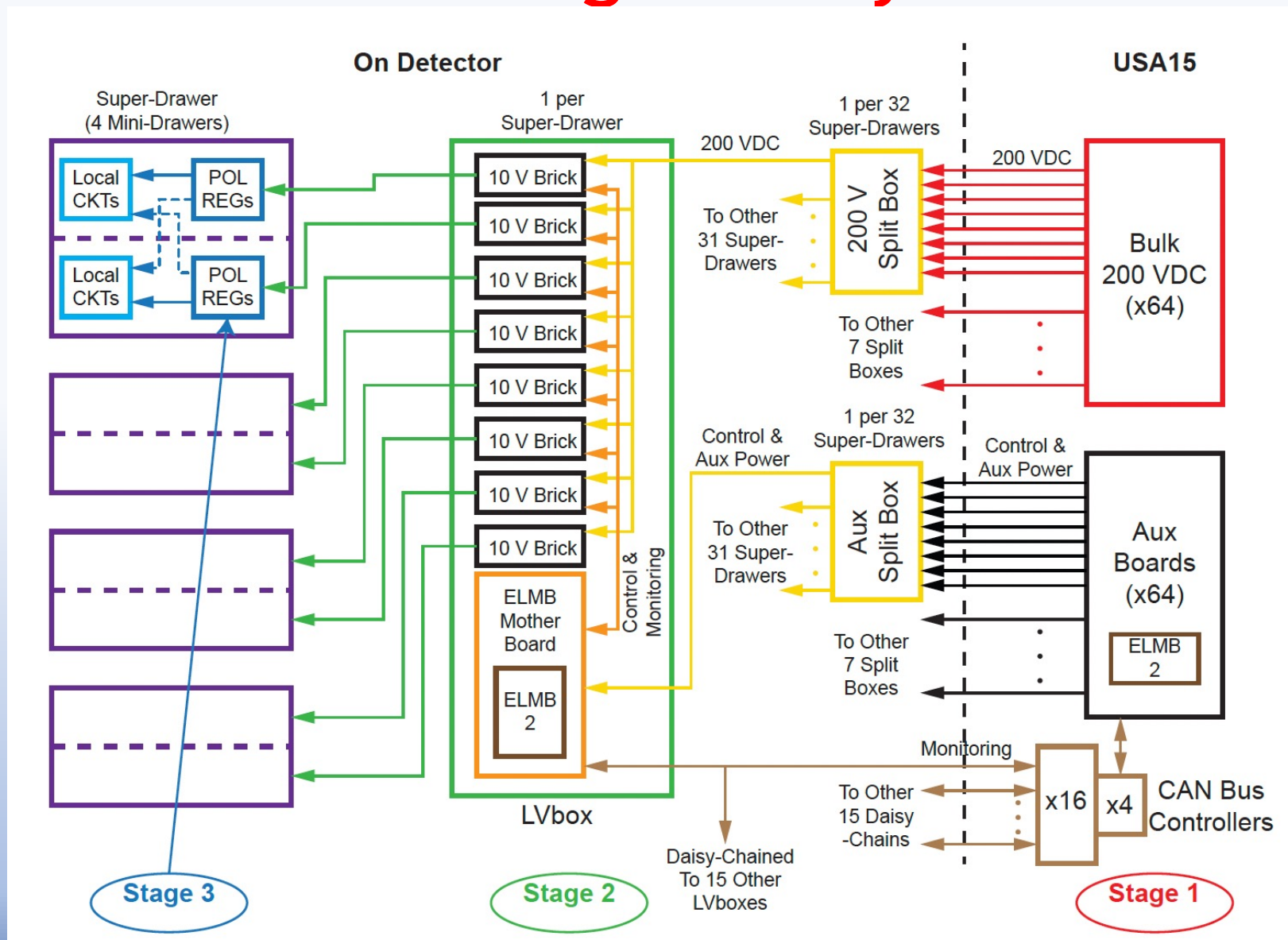
Trigger DAQ interface (TDAQi)



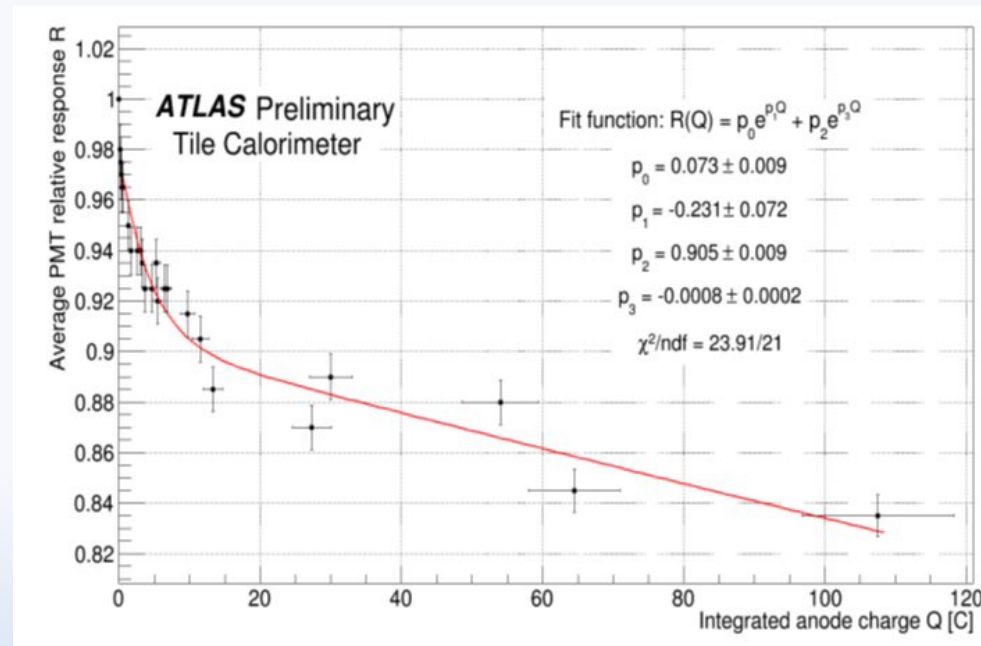
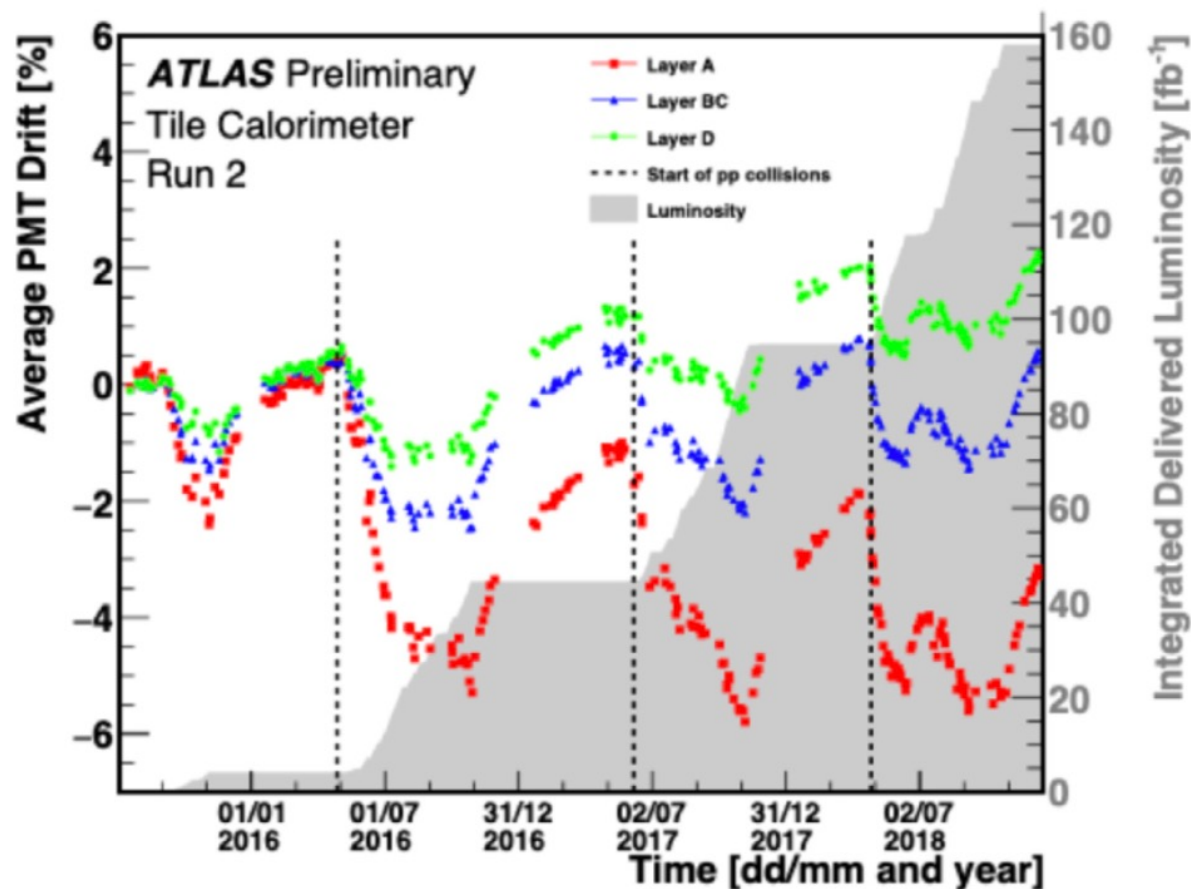
Compact Processing Module (CPM)



# Three-stages LV system



The block diagram of the TileCal low-voltage distribution system for the HL-LHC upgrade. The “10 V bricks” stand for 200 V DC to 10 V DC converters. The stage 3 is implemented directly on the front-end electronics boards



Double exponential fit of the data representing the average response variation as a function of the integrated charge. Different cells (integrating different charges) are used in the plot.

Cell layer A : innermost layer, most irradiated cells, larger PMT anode current, larger response loss  
 Cell layer BC : intermediate layer  
 Cell layer D : outermost layer, less irradiated cells, smaller PMT anode current, no relevant response loss